

Vishay General Semiconductor

# **Glass Passivated Ultrafast Rectifier**



### **FEATURES**

- · Superectifier structure for high reliability condition
- · Cavity-free glass-passivated junction
- · Ultrafast reverse recovery time
- · Low forward voltage drop
- Low leakage current
- · Low switching losses, high efficiency
- High forward surge capability
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- AEC-Q101 qualified
- · Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

### **TYPICAL APPLICATIONS**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer and telecommunication.

### **MECHANICAL DATA**

Case: GP20, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

<b>MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	EGP30A	EGP30B	EGP30C	EGP30D	EGP30F	EGP30G	UNIT	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	150	200	300	400	V	
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	210	280	V	
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	150	200	300	400	V	
Maximum average forward rectified current 0.375" (9.5 mm) lead length at $T_A = 55$ °C	I <sub>F(AV)</sub>	I <sub>F(AV)</sub> 3.0						А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	ым 125						А	
Operating and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	T <sub>J</sub> , T <sub>STG</sub> - 65 to + 150						°C	

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PRIMARY CHARACTERISTICS							
I <sub>F(AV)</sub> 3.0 A							
V <sub>RRM</sub>	50 V to 400 V						
I <sub>FSM</sub>	125 A						
t <sub>rr</sub>	50 ns						
V <sub>F</sub>	0.95 V, 1.25 V						
T <sub>J</sub> max.	150 °C						



RoHS COMPLIANT



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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	EGP30A	EGP30B	EGP30C	EGP30D	EGP30F	EGP30G	UNIT
Maximum instantaneous forward voltage	3.0 A		V <sub>F</sub>	0.95 1.25				25	v	
Maximum DC		T <sub>A</sub> = 25 °C		5.0						
reverse current at rated DC blocking voltage		T <sub>A</sub> = 125 °C	IR	100						μA
Maximum reverse recovery time	I <sub>F</sub> = 0.5 I <sub>rr</sub> = 0.2	A, I <sub>R</sub> = 1.0 A, 5 A	t <sub>rr</sub>	rr 50				ns		
Typical junction capacitance	4.0 V, 1	MHz	CJ	85		75		pF		

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	SYMBOL EGP30A EGP30B EGP30C EGP30D EGP30F EGP3				EGP30G	UNIT		
	R <sub>0JA</sub> <sup>(1)</sup>	20						°C/W
Typical thermal resistance	$R_{\theta JL}$ <sup>(1)</sup>	8.0						C/W

#### Note

<sup>(1)</sup> Thermal resistance from junction to ambient, and from junction to lead at 0.375" (9.5 mm) lead length, PCB mounted

ORDERING INFORMATION (Example)									
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE					
EGP30G-E3/54	1.01	54	1400	13" diameter paper tape and reel					
EGP30G-E3/73	1.01	73	1000	Ammo pack packaging					
EGP30GHE3/54 (1)	1.01	54	1400	13" diameter paper tape and reel					
EGP30GHE3/73 <sup>(1)</sup>	1.01	73	1000	Ammo pack packaging					

#### Note

(1) AEC-Q101 qualified

### **RATINGS AND CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25 °C unless otherwise noted)

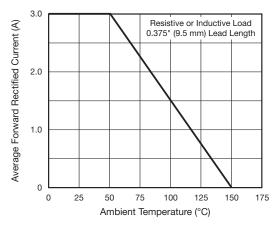


Fig. 1 - Maximum Forward Current Derating Curve

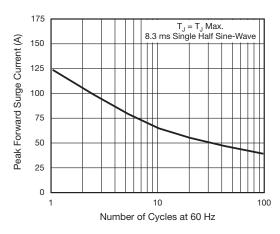


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

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## EGP30A thru EGP30G

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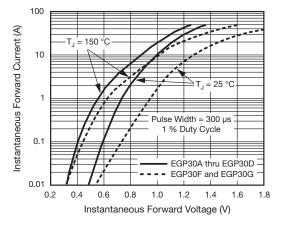


Fig. 3 - Typical Instantaneous Forward Characteristics

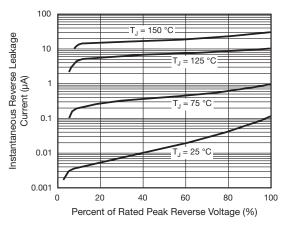


Fig. 4 - Typical Reverse Leakage Characteristics

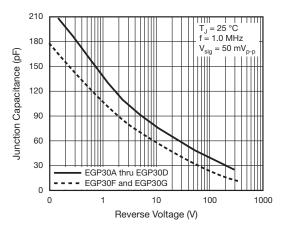


Fig. 5 - Typical Junction Capacitance

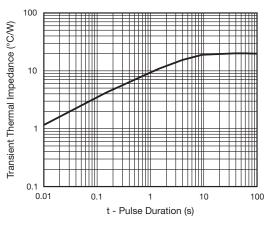
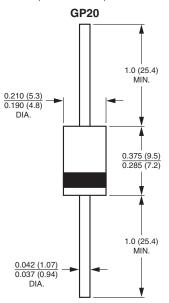


Fig. 6 - Typical Transient Thermal Impedance

#### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)



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